

HM7N80 / HM7N80F 800V N-Channel MOSFET

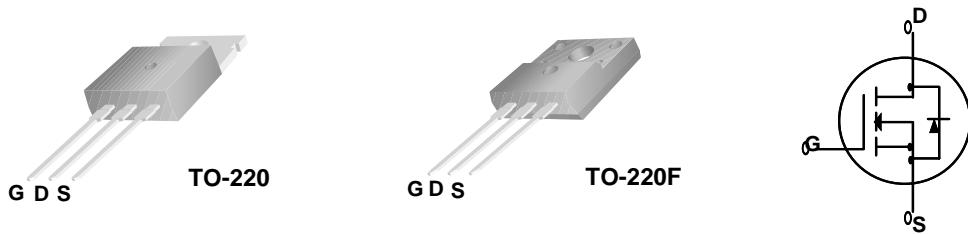
General Description

This Power MOSFET is produced using SL semi's advanced planar stripe DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

Features

- 7.0A, 800V, $R_{DS(on)} = 1.90\Omega$ @ $V_{GS} = 10\text{ V}$
- Low gate charge (typical 27nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	HM7N80	HM7N80F	Units
V_{DSS}	Drain-Source Voltage	800		V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	7.0	7.0*	A
	- Continuous ($T_C = 100^\circ\text{C}$)	4.2	4.2*	A
I_{DM}	Drain Current - Pulsed	(Note 1)	28	A
V_{GSS}	Gate-Source Voltage		± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	650	mJ
E_{AR}	Repetitive Avalanche Energy	(Note 1)	16.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	167	56	W
	- Derate above 25°C	1.33	0.44	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	$^\circ\text{C}$

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	HM7N80	HM7N80F	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.75	2.25	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	800	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	1	--	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 800 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	10	μA
		$V_{\text{DS}} = 640 \text{ V}, T_C = 125^\circ\text{C}$	--	--	100	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	3.0	--	5.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}, I_D = 3.5 \text{ A}$	--	1.4	1.9	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	1300	--	pF
C_{oss}	Output Capacitance		--	120	--	pF
C_{rss}	Reverse Transfer Capacitance		--	10	--	pF
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 400 \text{ V}, I_D = 7.0 \text{ A}, R_G = 25 \Omega$	--	40	--	ns
t_r	Turn-On Rise Time		--	100	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	50	--	ns
t_f	Turn-Off Fall Time		--	60	--	ns
Q_g	Total Gate Charge	$V_{\text{DS}} = 640 \text{ V}, I_D = 7.0 \text{ A}, V_{\text{GS}} = 10 \text{ V}$	--	27	-	nC
Q_{gs}	Gate-Source Charge		--	8	--	nC
Q_{gd}	Gate-Drain Charge		--	11	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	7.0	--	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	28	--	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_S = 7.0 \text{ A}$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}, I_S = 7.0 \text{ A}, dI_F / dt = 100 \text{ A}/\mu\text{s}$	--	650	--	ns
Q_{rr}	Reverse Recovery Charge		(Note 4)	--	7.0	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 25\text{mH}$, $I_{AS} = 7.0 \text{ A}$, $V_{DD} = 50\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{Sp} \leq 7.0 \text{ A}$, $dI/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq \text{BV}_{\text{DSS}}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

Typical Characteristics

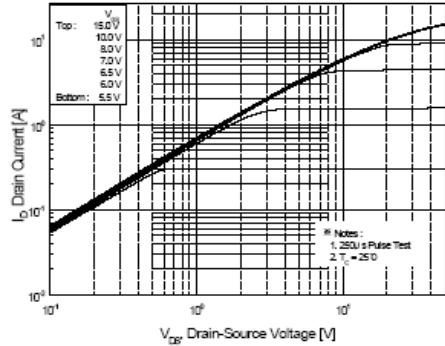


Figure 1. On-Region Characteristics

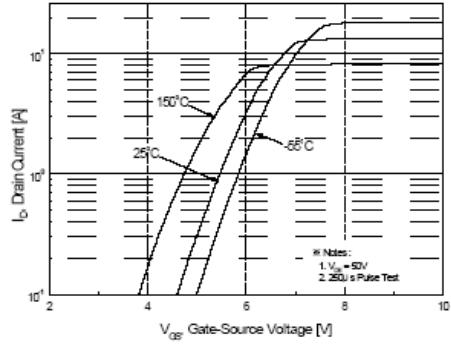


Figure 2. Transfer Characteristics

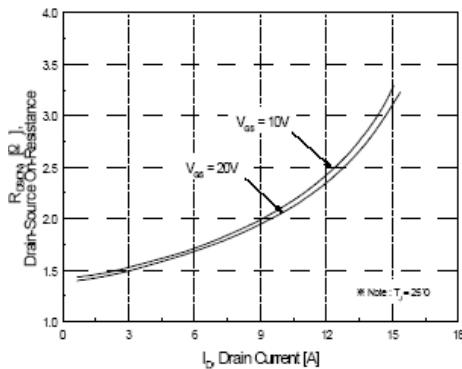


Figure 3. On-Resistance Variation vs
Drain Current and Gate Voltage

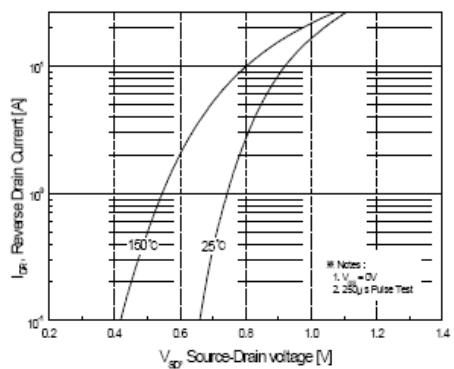


Figure 4. Body Diode Forward Voltage
Variation with Source Current
and Temperature

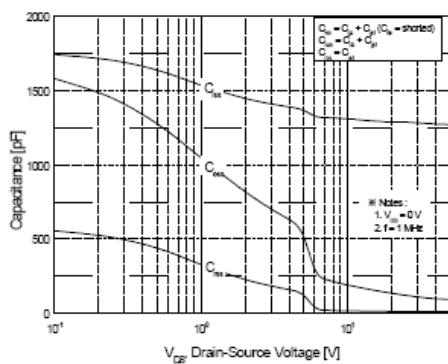


Figure 5. Capacitance Characteristics

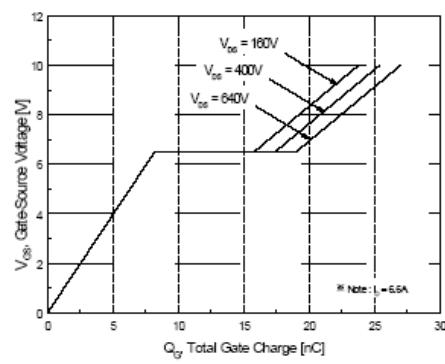


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

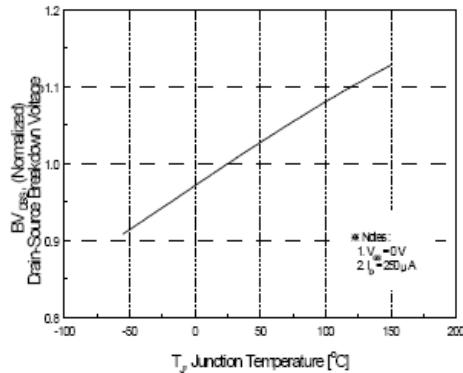


Figure 7. Breakdown Voltage Variation vs Temperature

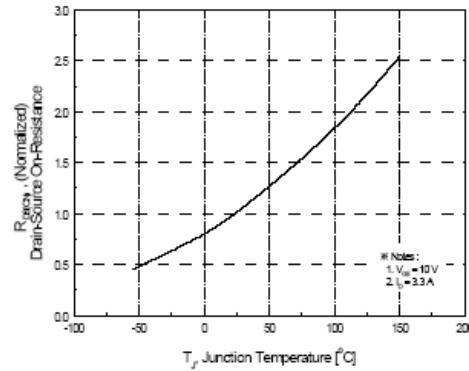


Figure 8. On-Resistance Variation vs Temperature

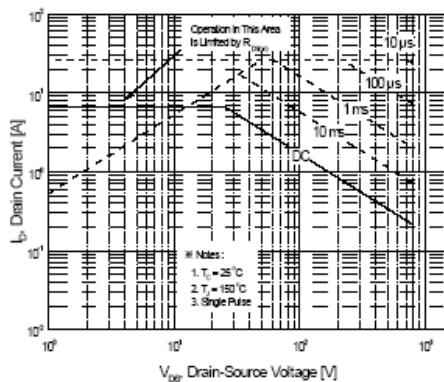


Figure 9-1. Maximum Safe Operating Area for HM7N80

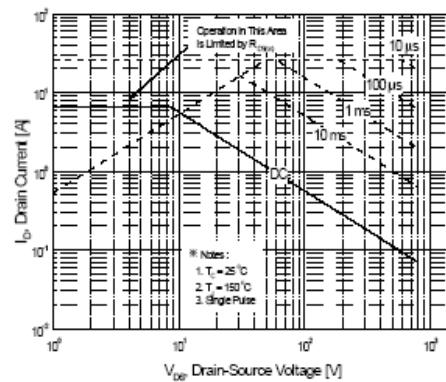


Figure 9-2. Maximum Safe Operating Area for HM7N80F

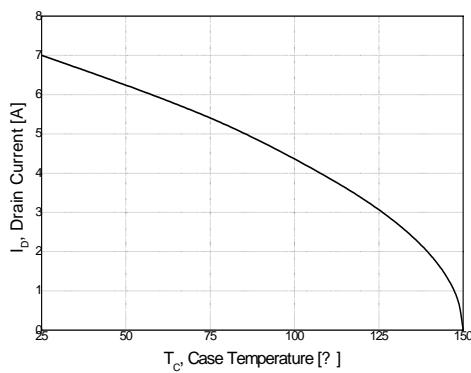


Figure 10. Maximum Drain Current vs Case Temperature

Typical Characteristics (Continued)

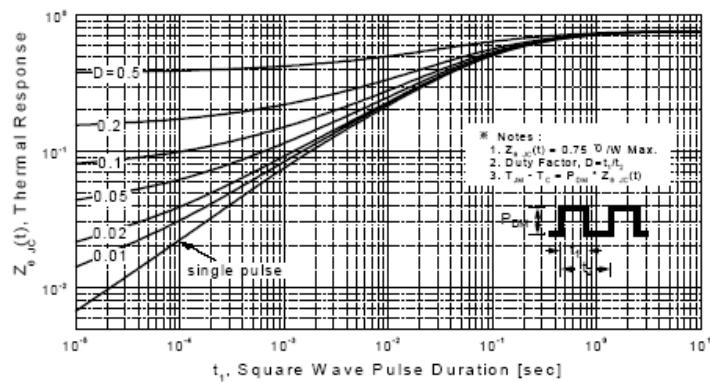


Figure 11-1. Transient Thermal Response Curve
for HM7N80

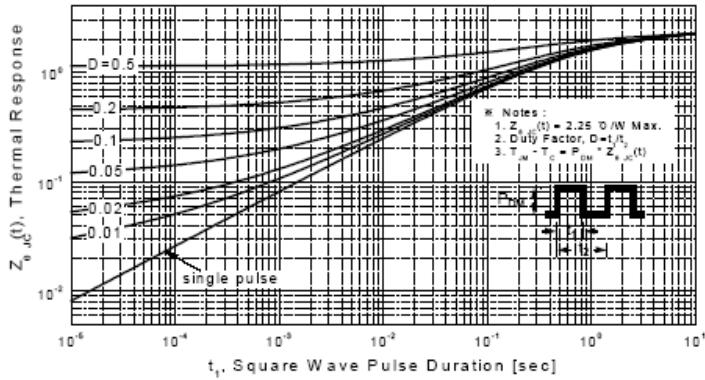
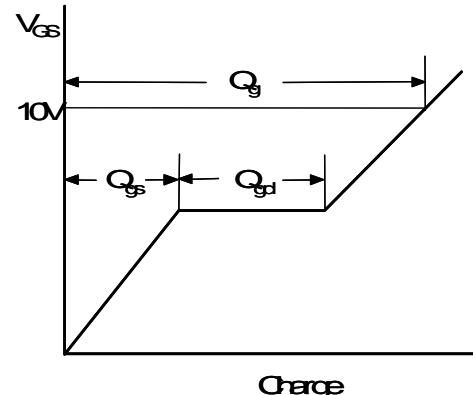
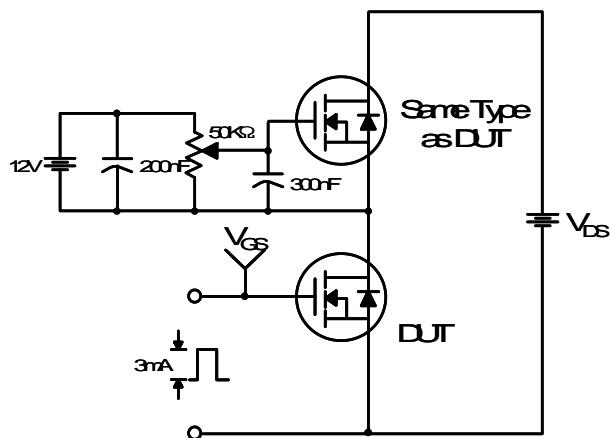
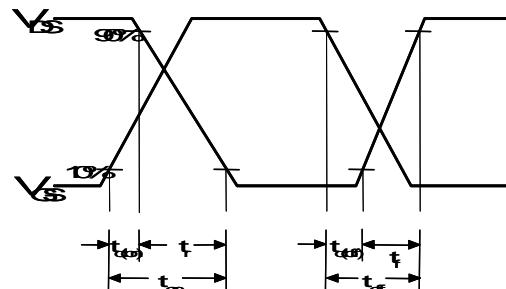
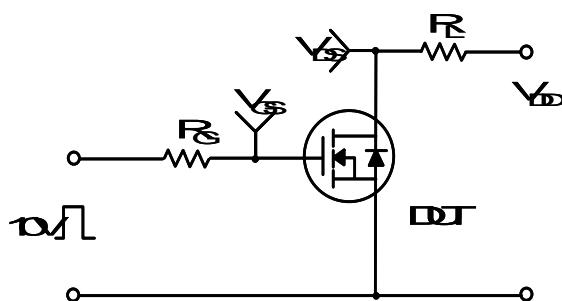


Figure 11-2. Transient Thermal Response Curve
for HM7N80F

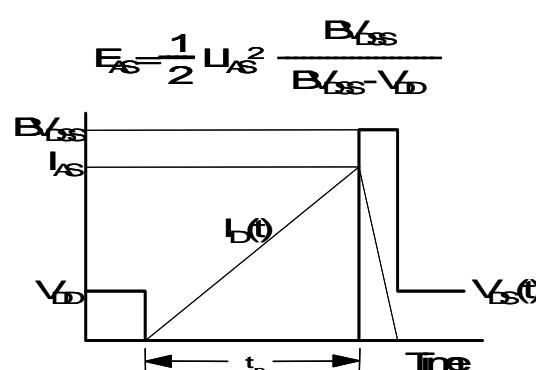
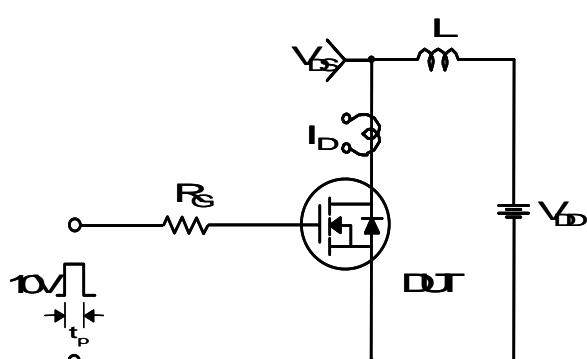
Gate Charge Test Circuit & Waveform



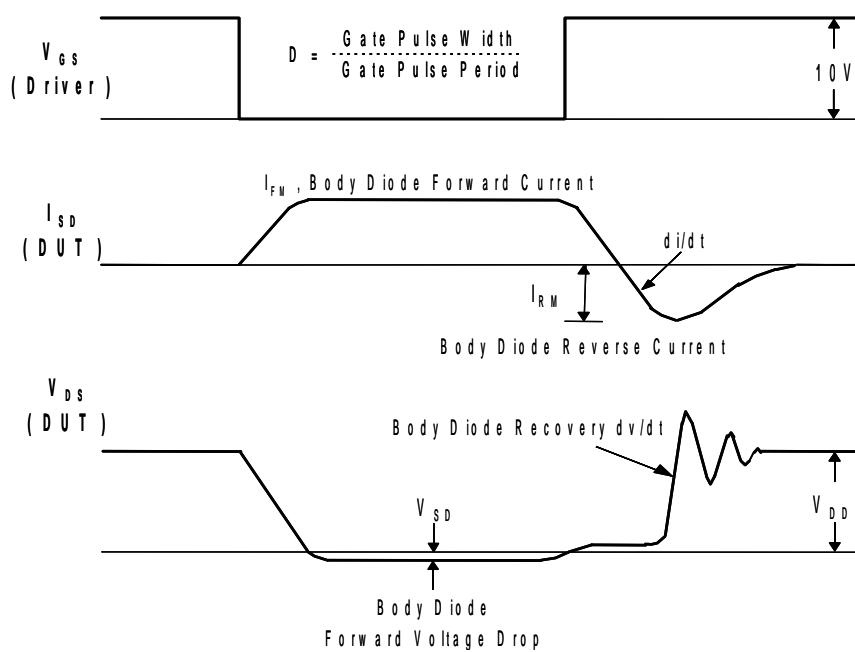
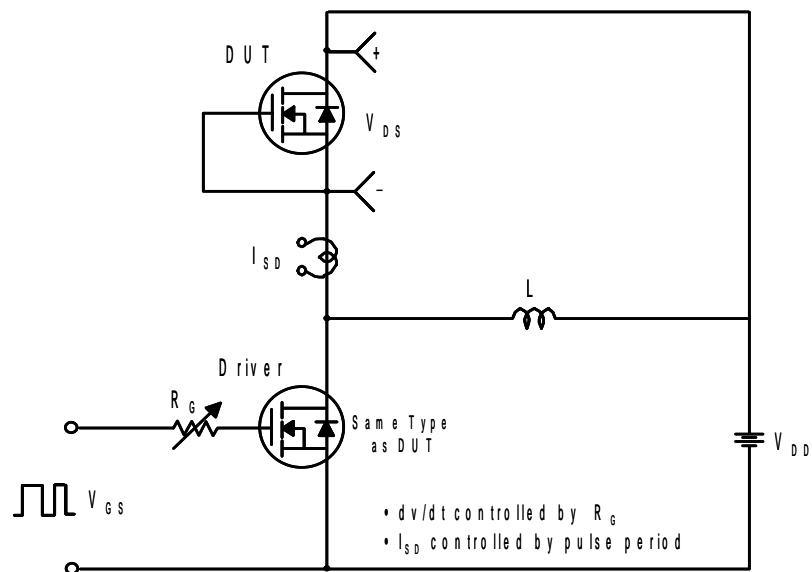
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



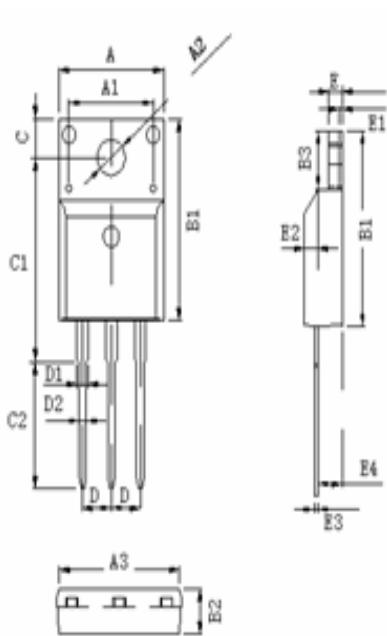
Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions

TO-220F

TO-220F 外形尺寸图



DIM.	MILLIMETERS
A	10.03 ± 0.20
A1	7.00
A2	3.12 ± 0.10
A3	9.70 ± 0.20
B1	15.75 ± 0.20
B2	4.72 ± 0.20
B3	6.70 ± 0.20
C	3.30 ± 0.10
C1	15.80 ± 0.20
C2	9.80 ± 0.2
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80 ± 0.10
E	2.55 ± 0.20
E1	0.70
E2	1.00 × 45°
E3	0.50
E4	2.80 ± 0.20